

Silicon Fast Recovery Diode

$V_{RRM} = 50\text{ V} - 400\text{ V}$

$I_F = 12\text{ A}$

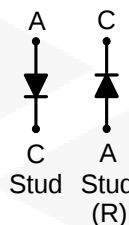
Features

- High Surge Capability
- Types up to 400 V V_{RRM}
- Not ESD Sensitive

Note:

1. Standard polarity: Stud is cathode.
2. Reverse polarity (R): Stud is anode.
3. Stud is base.

DO-4 Package



Maximum ratings, at $T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified ("R" devices have leads reversed)

Parameter	Symbol	Conditions	1N3889 (R)	1N3890 (R)	1N3891 (R)	1N3892 (R)	1N3893 (R)	Unit
Repetitive peak reverse voltage	V_{RRM}		50	100	200	300	400	V
RMS reverse voltage	V_{RMS}		35	70	140	280	420	V
DC blocking voltage	V_{DC}		50	100	200	400	600	V
Continuous forward current	I_F	$T_C \leq 100\text{ }^{\circ}\text{C}$	12	12	12	12	12	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25\text{ }^{\circ}\text{C}$, $t_p = 8.3\text{ ms}$	90	90	90	90	90	A
Operating temperature	T_j		-55 to 150	-55 to 150	-55 to 150	-55 to 150	-55 to 150	$^{\circ}\text{C}$
Storage temperature	T_{stg}		-55 to 150	-55 to 150	-55 to 150	-55 to 150	-55 to 150	$^{\circ}\text{C}$

Electrical characteristics, at $T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	1N3889 (R)	1N3890 (R)	1N3891 (R)	1N3892 (R)	1N3893 (R)	Unit
Diode forward voltage	V_F	$I_F = 12\text{ A}$, $T_j = 25\text{ }^{\circ}\text{C}$	1.4	1.4	1.4	1.4	1.4	V
Reverse current	I_R	$V_R = 50\text{ V}$, $T_j = 25\text{ }^{\circ}\text{C}$	25	25	25	25	25	μA
		$V_R = 50\text{ V}$, $T_j = 150\text{ }^{\circ}\text{C}$	6	6	6	6	6	mA

Recovery Time

Maximum reverse recovery time	T_{RR}	$I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{RR} = 0.25\text{ A}$	200	200	200	200	200	nS
-------------------------------	----------	---	-----	-----	-----	-----	-----	----

Thermal characteristics

Thermal resistance, junction - case	R_{thJC}		2.0	2.0	2.0	2.0	2.0	$^{\circ}\text{C/W}$
-------------------------------------	------------	--	-----	-----	-----	-----	-----	----------------------

Figure .1-Typical Forward Characteristics

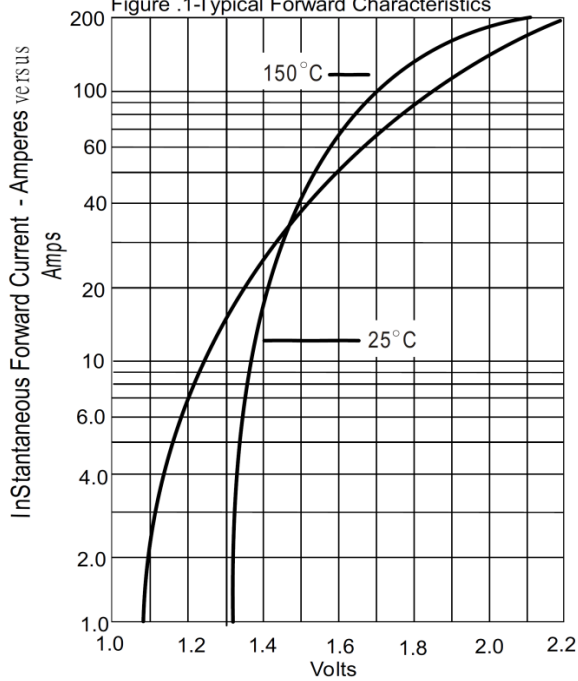


Figure .2-Forward Derating Curve

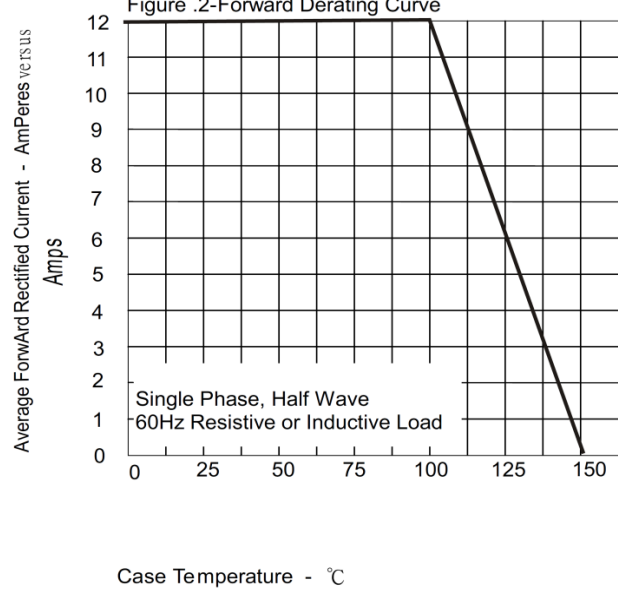


Figure .3-Peak Forward Surge Current

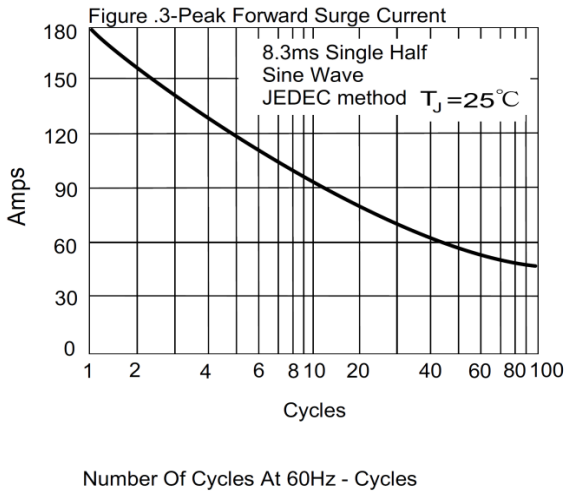
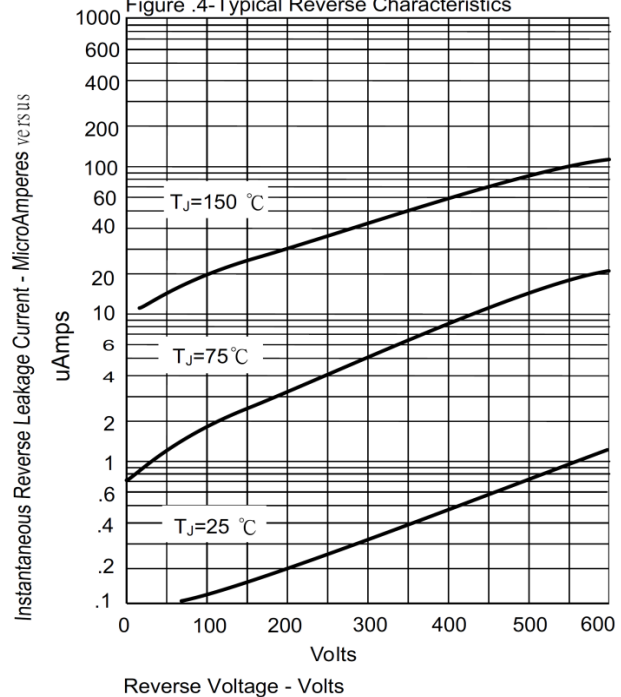
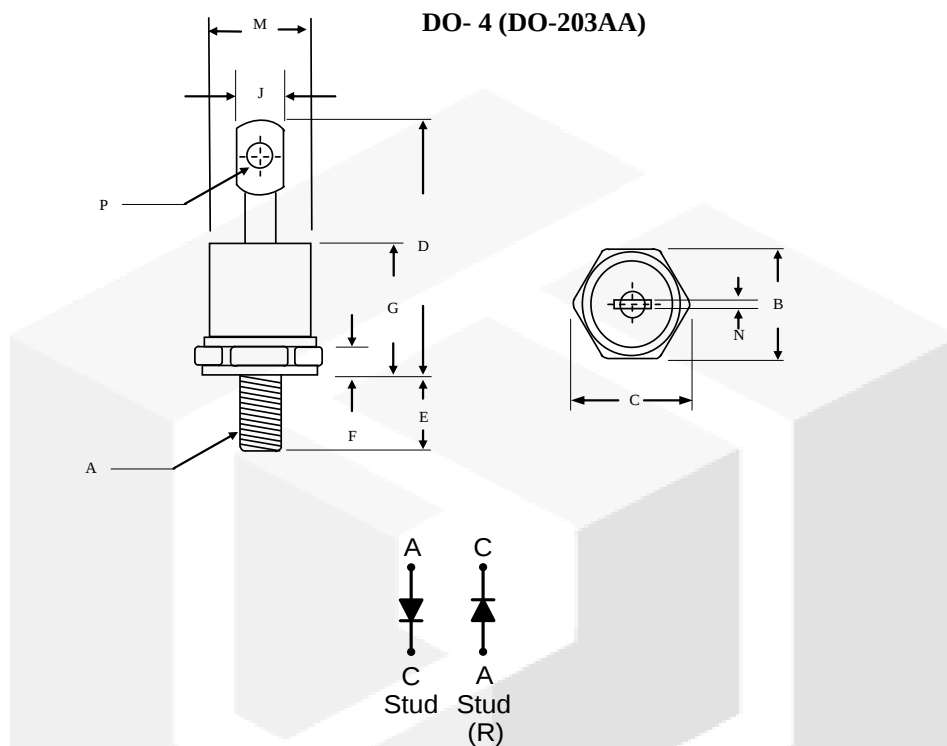


Figure .4-Typical Reverse Characteristics



Package dimensions and terminal configuration

Product is marked with part number and terminal configuration.



	Inches		Millimeters	
	Min	Max	Min	Max
A	10-32 UNF			
B	0.424	0.437	10.77	11.10
C	-----	0.505	-----	12.82
D	-----	0.800	-----	20.30
E	0.453	0.492	11.50	12.50
F	0.114	0.140	2.90	3.50
G	-----	0.405	-----	10.29
J	-----	0.216	-----	5.50
M	-----	φ0.302	-----	φ7.68
N	0.031	0.045	0.80	1.15
P	0.070	0.79	1.80	2.00

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[GeneSiC Semiconductor:](#)

[1N3889R](#)